

1752-2 1.1

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Declaration Class* Form Type* Distribute Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infomation

Supplier Information								
Company Unique ID Unique ID Authority		Response Date*						
0-489-5751	Dun & Bradstreet	Sat, Aug 09, 2014 03:40 AM						
itle - Contact	Phone - Contact *	Email - Contact *						
roduct Ecology 8	801-562-7455	david.lancaster@fairchildsemi.com						
itle - Representative	Phone - Representative *	Email - Representative *						
roduct Ecology	801-562-7455	david.lancaster@fairchildsemi.com						
C Ti	0-489-5751 tle - Contact oduct Ecology tle - Representative	0-489-5751 Dun & Bradstreet tle - Contact Phone - Contact * oduct Ecology 801-562-7455 tle - Representative Phone - Representative *						

Requester Item Number	Item Number Mfr Item Number		Mfr Item Name		Effective Date	Version		Manufacturing Site	Weight*	UOM	Unit Type	
MJE350STU	MJE350STU		TO-126 (Pb93.5Sn5Ag1.5)				SUBCONTRACTOR		0.882407	g	Each	
Manufacturing Process Information												
Terminal Finish	Base Alloy	J-STD-0	20 MSL Rating F		Peak Process Body Temperature		Max Time at Peak Temperature		No Reflow cycles			
Matte Tin (Sn)	CU Alloy	Not	Not Applicable		С			seconds		Not A	Not Applicable	

* Required Field

RoHS Material Composition Declaration	Declaration Type * Custom							
RoHS Directive 2011/65/EURoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium								
This document is Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this document is based upon information collected from Fairchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.								
The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems to ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.								
Note: The substance content disclosed herewith is approximate and is based on various methods including, engineering calculations, supplier surveys, Material Safety Data Sheets, analytical measurements. Fairchild may update this document without notification. This statement may not include information regarding the miniscule quantities of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed for Resin substances are generic and may contain alternate substances of similar composition.								
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substances per the definition above except for selected exemptions Sup	plier Acceptance * Accepted							
Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.								
Exemption List Version EL-2011/534/EU								
7(a)-Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85 % by weight or more lead).								

Declaration Signature

David Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name TO-126 (Pb93.5Sn5Ag1.5)

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	0.380	Supplier		Silicon	0.380	7440-21-3	431
Die Attach	Other Nonferrous metals & alloys	0.230	А	Lead/Lead Compounds	Lead	0.215	7439-92-1	243
			Supplier		Silver	0.003	7440-22-4	4
			Supplier		Tin	0.011	7440-31-5	13
Encapsulation	Thermoplastics	468.300	В	Antimony/Antimony Compounds	Antimony Trioxide	11.700	1309-64-4	13259
			В	Brominated Flame Retardants (other than PBCs or PBDEs)	Bromine Resin	14.000	6386-73-8	15866
			Supplier		Carbon Black	4.683	1333-86-4	5307
			Supplier		Epoxy Resin	93.600	29690-82-2	106074
			Supplier		Silica, vitreous	344.317	60676-86-0	390202
Lead Frame	Copper & its alloys	397.898	Supplier		Copper	397.000	7440-50-8	449906
			Supplier		Iron	0.398	7439-89-6	451
			Supplier		Phosphorus	0.119	7723-14-0	135
			Supplier		Silver	0.381	7440-22-4	432
Plating	Other Nonferrous metals & alloys	15.300	Supplier		Tin	15.300	7440-31-5	17339
Wire Bond	Precious metals	0.299	Supplier		Gold	0.299	7440-57-5	339